



Product Change Notification

Change Notification #: 118284-00
Change Title: Select Intel® Wireless 3100 Series,
PCN 118284-00, Label, Transport Media
Label and Transport Media Updates
Date of Publication: May 26, 2021

Key Characteristics of the Change:
Label, Transport Media

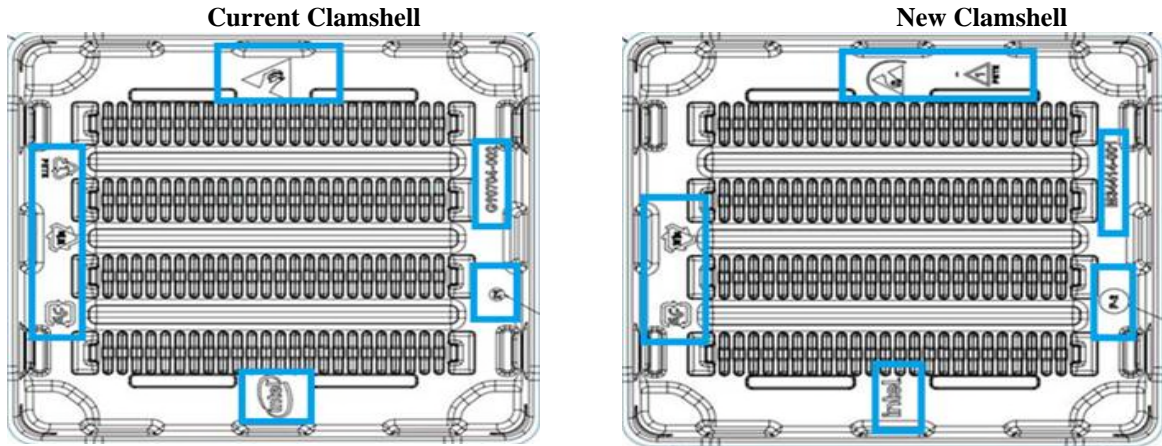
Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	June 10, 2021
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Description of Change to the Customer:

The Intel® Wireless-AC3165 2230 SKUs listed in the products affected table below will undergo the following changes.

1. Change clamshell to new part number M34396-001 with new Intel Logo and markings.

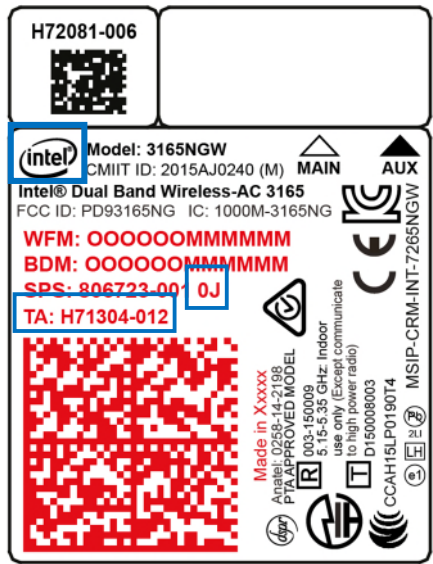



2. Update Singapore IMDA ID.
3. Update UK/Brexit table on Distri label.
4. Update new Intel logo on product label.
5. The Intel tracking revision will be changed on the following product.


Product Code	Before	After
3165.NGWG	0J	0K

6. Product TA# dash up.


Example Labels 3165.NGWG

Product - Before	Product - After
 <p>Product label before: Model: 3165NGW, MIIT ID: 2015AJ0240 (M), MAIN, AUX, Intel® Dual Band Wireless-AC 3165, FCC ID: PD93165NG IC: 1000M-3165NG, WFM: OOOOOOMMMMMM, BDM: OOOOOOMMMMMM, SPS: 806723-001 OJ, TA: H71304-012</p>	 <p>Product label after: Model: 3165NGW, MIIT ID: 2015AJ0240 (M), MAIN, AUX, Intel® Dual Band Wireless-AC 3165, FCC ID: PD93165NG IC: 1000M-3165NG, WFM: OOOOOOMMMMMM, BDM: OOOOOOMMMMMM, SPS: 806723-001 OK, TA: H71304-013</p>

Disti - Before	
<p>3165.NGWG</p> <p>VERSION #: H71304-012</p> <p>MADE IN CHINA WITH PARTIAL FOREIGN CONTENT</p> <p>CARTON #: VVXXXXXXXX</p>	<p>QTY: 100</p> <p>MM#: XXXXXX</p> <p>PACK DATE: DD MMM YY</p> <p>PACKED BY: XXXXXX</p> <p>BATCH #: CCVVYMDRSS</p>

Intel® Dual Band Wireless-AC 3165 (Model: 3165NGW)	
<p>PKG ID (3S) VVVVMMMMDDDD#####PPPPP100</p> <p>T P/N: GTTTTTTTTTT</p>	
<p>D P/N: P P P P P P REV AX X HP P/N: 803344-001 REV: O J</p> <p>PACKAGE WEIGHT: X.X LBS</p>	<p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1649 USA www.intel.com</p>
<p>Vendor ID Loc Id Mfg Id L P/N: XXXXXXXXXXXX</p> <p>VVVVVLLLLL MMMMM EC: XXXXXXXX</p>	<p>MSIP-CRM-INT-7265NGW</p>

Disti - After	
<p>3165.NGWG</p> <p>VERSION #: H71304-013</p> <p>MADE IN CHINA WITH PARTIAL FOREIGN CONTENT</p> <p>CARTON #: VVXXXXXXXX</p>	<p>QTY: 100</p> <p>MM#: XXXXXX</p> <p>PACK DATE: DD MMM YY</p> <p>PACKED BY: XXXXXX</p> <p>BATCH #: CCVVYMDRSS</p>

Intel® Dual Band Wireless-AC 3165 (Model: 3165NGW)	
<p>PKG ID (3S) VVVVMMMMDDDD#####PPPPP100</p> <p>T P/N: GTTTTTTTTTT</p>	
<p>D P/N: P P P P P P REV AX X HP P/N: 803344-001 REV: O K</p> <p>PACKAGE WEIGHT: X.X LBS</p>	<p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1649 USA www.intel.com</p>
<p>Vendor ID Loc Id Mfg Id L P/N: XXXXXXXXXXXX</p> <p>VVVVVLLLLL MMMMM EC: XXXXXXXX</p>	<p>MSIP-CRM-INT-7265NGW</p>

Customer Impact of Change and Recommended Action:

The label and packaging changes to the products do not affect functionality. Intel anticipates no impact to customers.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Post Change TA
Intel® Dual Band Wireless-AC 3165, 1x1 AC + BT, No vPro® M.2	3165.NGWG	940106	H71304-012	H71304-013
Intel® Dual Band Wireless-AC 3165, 1x1 AC + BT, No vPro® M.2, Low Power	3165.NGWG. S	940107	H72060-010	H72060-011

PCN Revision History:

Date of Revision:

May 26, 2021

Revision Number:

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Reason:

Originally Published PCN



Product Change Notification

118284-00

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The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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